



RF360
Europe GmbH

SAW components

SAW duplexer for small cell

LTE band 3

Series/type:	B8018
Ordering code:	B39182B8018P810
Date:	March 24, 2016
Version:	2.3

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SAW components	B8018
SAW duplexer for small cell	1747.5/1842.5

Data sheet

Table of contents

1	Application	3
2	Features	3
3	Package	4
4	Pin configuration	4
5	Matching circuit	5
6	Characteristics	6
7	Maximum ratings	9
8	Transmission coefficients	10
9	Reflection coefficients	13
10	EVMS	14
11	Packing material	16
12	Marking	19
13	Soldering profile	21
14	Annotations	22
15	Cautions and warnings	23
	Important notes	24

Data sheet

1 Application

- Low-loss SAW duplexer for LTE smallcell systems (Band 3)
- Low insertion attenuation
- High power durability
- Industrial qualification
- Usable pass band 75 MHz
- Rx = Uplink = 1710-1785 MHz
- Tx = Downlink = 1805-1880 MHz

2 Features

- Package size $2.5 \pm 0.1 \text{ mm} \times 2.0 \pm 0.1 \text{ mm}$
- Package height 0.5 mm (max.)
- Approximate weight 1 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 2a (MSL2a)

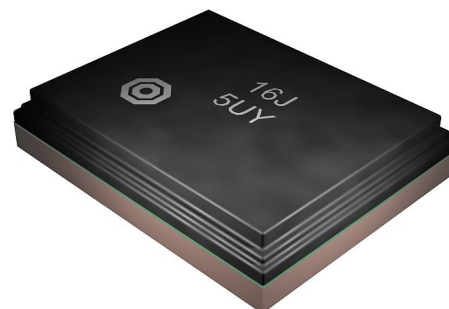


Figure 1: Picture of component with example of product marking.

Data sheet

5 Matching circuit

■ $L_{p1} = 8.2 \text{ nH}$

■ $L_{p6} = 3.6 \text{ nH}$

■ $L_{p3} = 9.1 \text{ nH}$

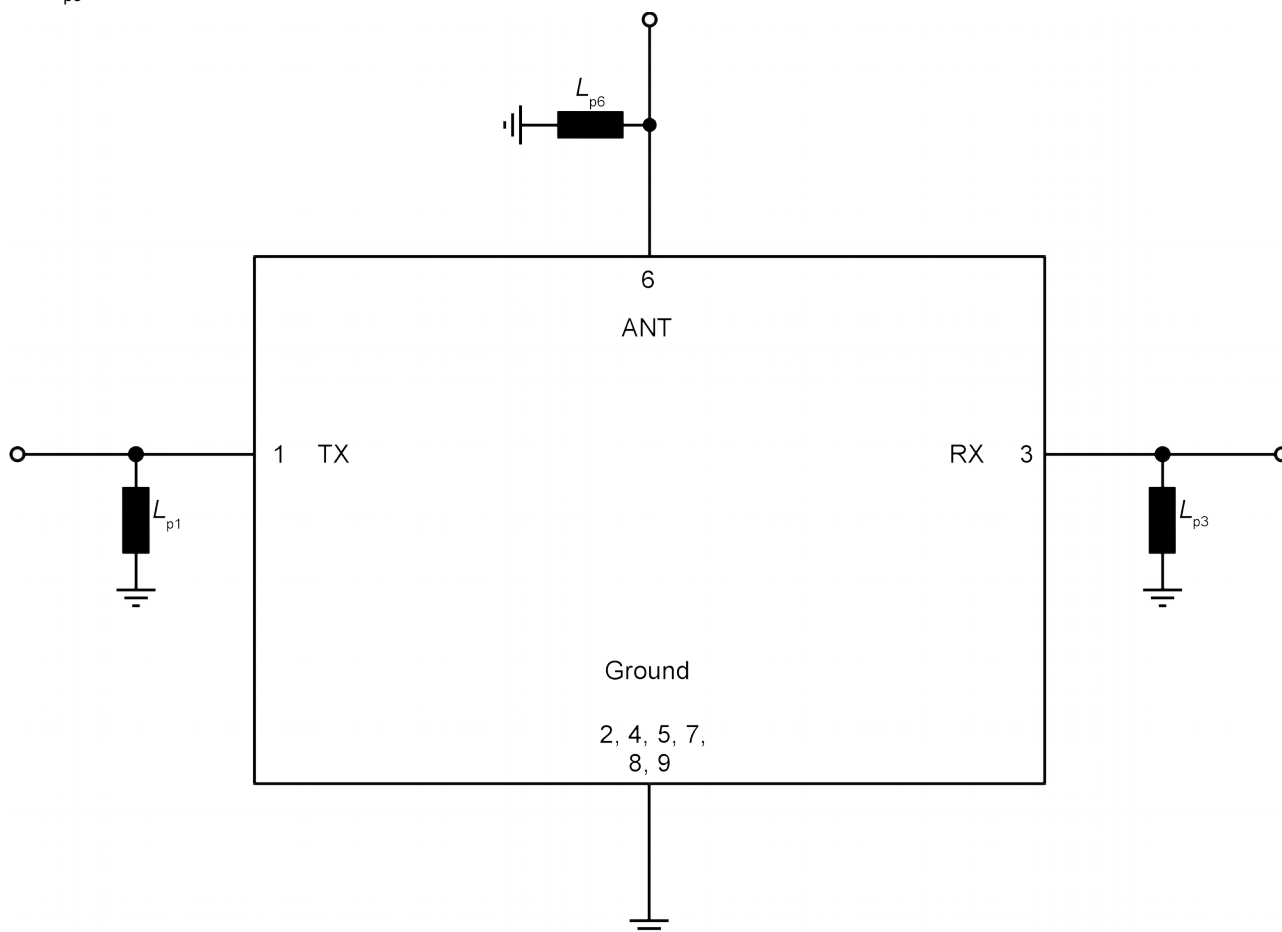


Figure 3: Schematic of matching circuit.

SAW components	B8018
SAW duplexer for small cell	1747.5/1842.5

Data sheet

6 Characteristics

6.1 TX – ANT

Temperature range for specification

T_{SPEC} = -10 °C ... +85 °C

TX terminating impedance

Z_{TX} = 50 Ω with par. 8.2 nH¹⁾

ANT terminating impedance

Z_{ANT} = 50 Ω with par. 3.6 nH¹⁾

RX terminating impedance

Z_{RX} = 50 Ω with par. 9.1 nH¹⁾

Characteristics TX – ANT				min. for T_{SPEC}	typ. @+25 °C	max. for T_{SPEC}	
Center frequency			f_C	—	1842.5	—	MHz
Maximum insertion attenuation			α_{max}				
	1805... 1880	MHz		—	2.6	4.0	dB
	1840... 1870	MHz		—	1.7	2.5	dB
Amplitude ripple (p-p)			$\Delta\alpha$				
	1805... 1880	MHz		—	1.2	3.0	dB
	1840... 1870	MHz		—	0.3	1.0	dB
Maximum VSWR			VSWR _{max}				
@ TX port	1805... 1880	MHz		—	1.4	2.0	
@ ANT port	1805... 1880	MHz		—	1.5	2.0	
Average error vector magnitude			EVM _{avg} ²⁾				
	1807.5... 1877.5	MHz		—	1.6	3.5	%
Minimum attenuation			α_{min}				
	10... 1710	MHz		30	34	—	dB
	1710... 1745	MHz		42	46	—	dB
	1745... 1780	MHz		45	49	—	dB
	1780... 1785	MHz		35	48	—	dB
	1900... 1911	MHz		5	18	—	dB
	1911... 1920	MHz		20	63	—	dB
	1920... 1980	MHz		40	45	—	dB
	1980... 2400	MHz		35	40	—	dB
	2400... 2500	MHz		35	41	—	dB
	2500... 3680	MHz		30	41	—	dB
	3680... 3740	MHz		30	49	—	dB
	3740... 5150	MHz		30	38	—	dB
	5150... 5725	MHz		25	33	—	dB

¹⁾ See Sec. Matching circuit (p. 5).

²⁾ Error Vector Magnitude (EVM) based on definition given in 3GPP TS 25.141.

SAW components	B8018
SAW duplexer for small cell	1747.5/1842.5

Data sheet

6.2 ANT – RX

Temperature range for specification	T_{SPEC}	= -10 °C ... +85 °C
TX terminating impedance	Z_{TX}	= 50 Ω with par. 8.2 nH ¹⁾
ANT terminating impedance	Z_{ANT}	= 50 Ω with par. 3.6 nH ¹⁾
RX terminating impedance	Z_{RX}	= 50 Ω with par. 9.1 nH ¹⁾

Characteristics ANT – RX				min. for T_{SPEC}	typ. @+25 °C	max. for T_{SPEC}	
Center frequency			f_C	—	1747.5	—	MHz
Maximum insertion attenuation			α_{max}	—	3.5	5.3	dB
	1710... 1785	MHz		—	2.5	3.0	dB
	1745... 1775	MHz		—	2.5	3.0	dB
Amplitude ripple (p-p)			$\Delta\alpha$	—	2.2	4.0	dB
	1710... 1785	MHz		—	1.0	1.5	dB
	1745... 1775	MHz		—	1.0	1.5	dB
Maximum VSWR			VSWR _{max}	—	1.6	2.0	
@ ANT port	1710... 1785	MHz		—	1.8	2.2	
@ RX port	1710... 1785	MHz		—	1.8	2.2	
Average error vector magnitude			EVM _{avg} ²⁾	—	2.5	4.0	%
	1712.5... 1782.5	MHz		—	2.5	4.0	%
Minimum attenuation			α_{min}	40	49	—	dB
	10... 1500	MHz		40	48	—	dB
	1500... 1660	MHz		10	15	—	dB
	1660... 1690	MHz		40	44	—	dB
	1805... 1840	MHz		43	47	—	dB
	1840... 1880	MHz		40	45	—	dB
	1880... 2400	MHz		40	45	—	dB
	2400... 2500	MHz		35	50	—	dB
	2500... 3490	MHz		35	51	—	dB
	3490... 3550	MHz		35	42	—	dB
	3500... 5235	MHz		35	42	—	dB
	5235... 5325	MHz		35	42	—	dB

¹⁾ See Sec. Matching circuit (p. 5).

²⁾ Error Vector Magnitude (EVM) based on definition given in 3GPP TS 25.141.

Data sheet

6.3 TX – RX

Temperature range for specification

 $T_{SPEC} = -10\text{ °C} \dots +85\text{ °C}$

TX terminating impedance

 $Z_{TX} = 50\ \Omega$ with par. 8.2 nH¹⁾

ANT terminating impedance

 $Z_{ANT} = 50\ \Omega$ with par. 3.6 nH¹⁾

RX terminating impedance

 $Z_{RX} = 50\ \Omega$ with par. 9.1 nH¹⁾
Characteristics TX – RX

			min. for T_{SPEC}	typ. @+25 °C	max. for T_{SPEC}	
Minimum isolation						
		α_{min}				
1710... 1745	MHz		43	46	—	dB
1745... 1780	MHz		45	49	—	dB
1780... 1785	MHz		37	49	—	dB
1805... 1840	MHz		40	43	—	dB
1840... 1880	MHz		45	48	—	dB

¹⁾ See Sec. Matching circuit (p. 5).

SAW components	B8018
SAW duplexer for small cell	1747.5/1842.5

Data sheet

7 Maximum ratings

Storage temperature	$T_{STG} = -40\text{ °C} \dots +85\text{ °C}$	
DC voltage	$V_{DC} = 0\text{ V (max.)}$	
ESD voltage	$V_{ESD} = 50\text{ V (max.)}^{1)}$	
Input power	P_{IN}	
@ TX port: 1805 ... 1880 MHz	27 dBm	Source and load impedance 50Ω. LTE 5MHz downlink. T=55°C, 50.000h. ²⁾
@ TX port: 1805 ... 1880 MHz	26 dBm	Source and load impedance 50Ω. LTE 5MHz downlink. T=55°C, 100.000h. ²⁾
@ TX port: other frequency range(s)	10 dBm	Source and load impedance 50Ω.
Operating lifetime with output power at antenna	P_{OUT}	
@ ANT port: 1805 ... 1880 MHz	21 dBm	Continuous wave T= 55 °C, 100khrs. ³⁾

¹⁾ According to JESD22-A115A (machine model), 1 negative and 1 positive pulses.

²⁾ Time to failure (TTF) according to accelerated power durability tests, and wear out models.

³⁾ According to accelerated high temperature operating life (HOTL) test.

Data sheet

8 Transmission coefficients

8.1 TX – ANT

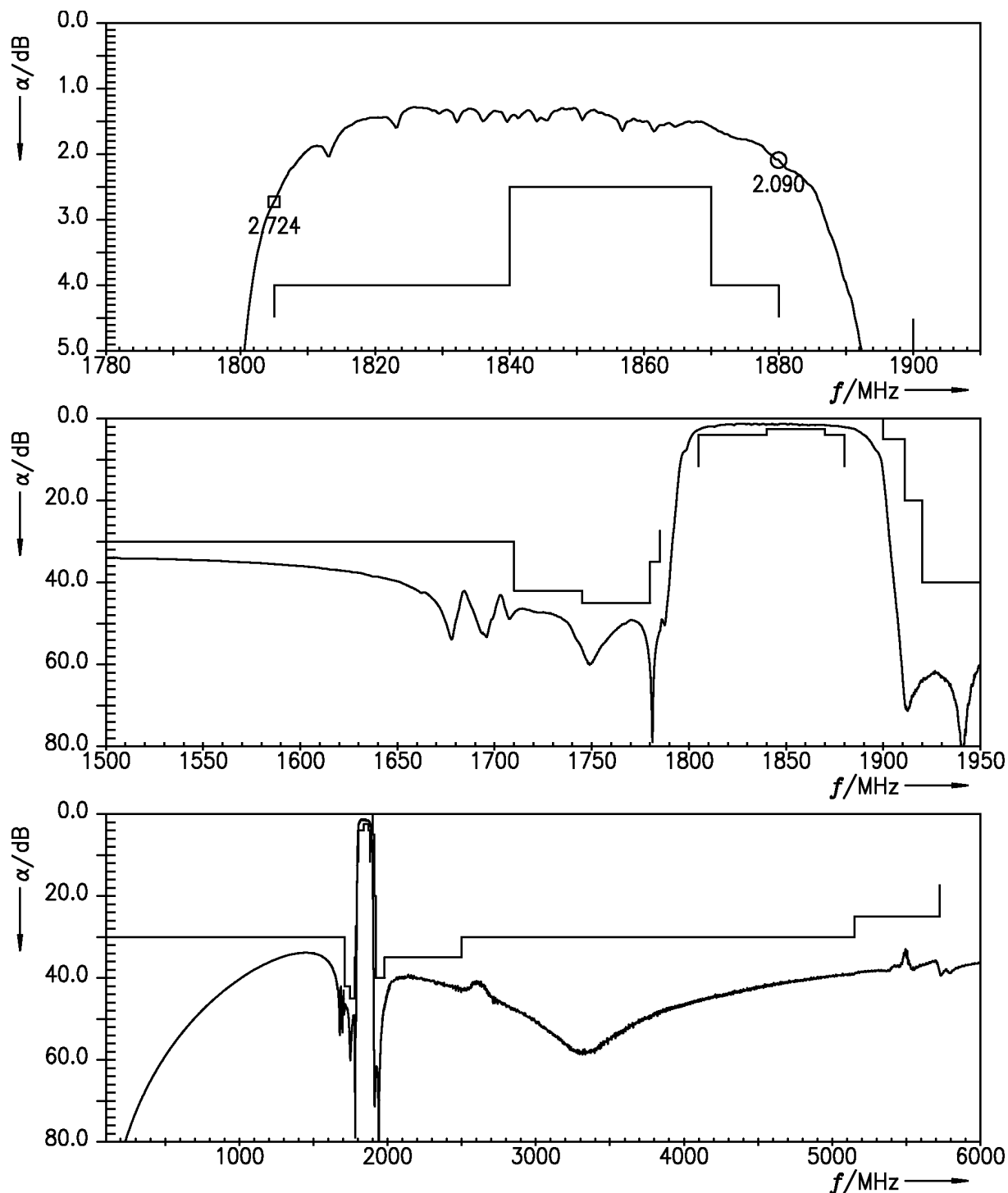


Figure 4: Attenuation TX – ANT.

Data sheet

8.2 ANT – RX

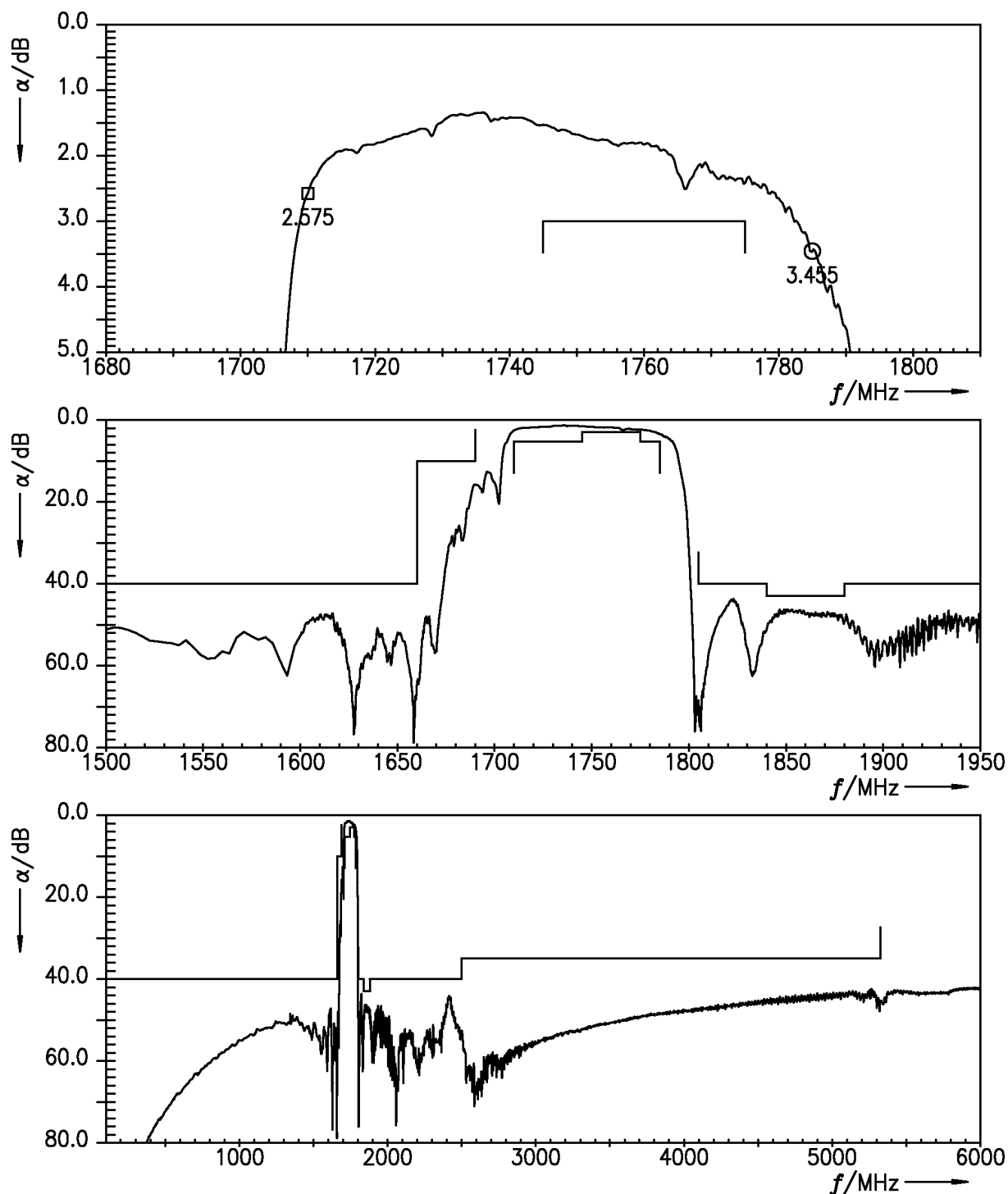


Figure 5: Attenuation ANT – RX.

Data sheet

8.3 TX – RX

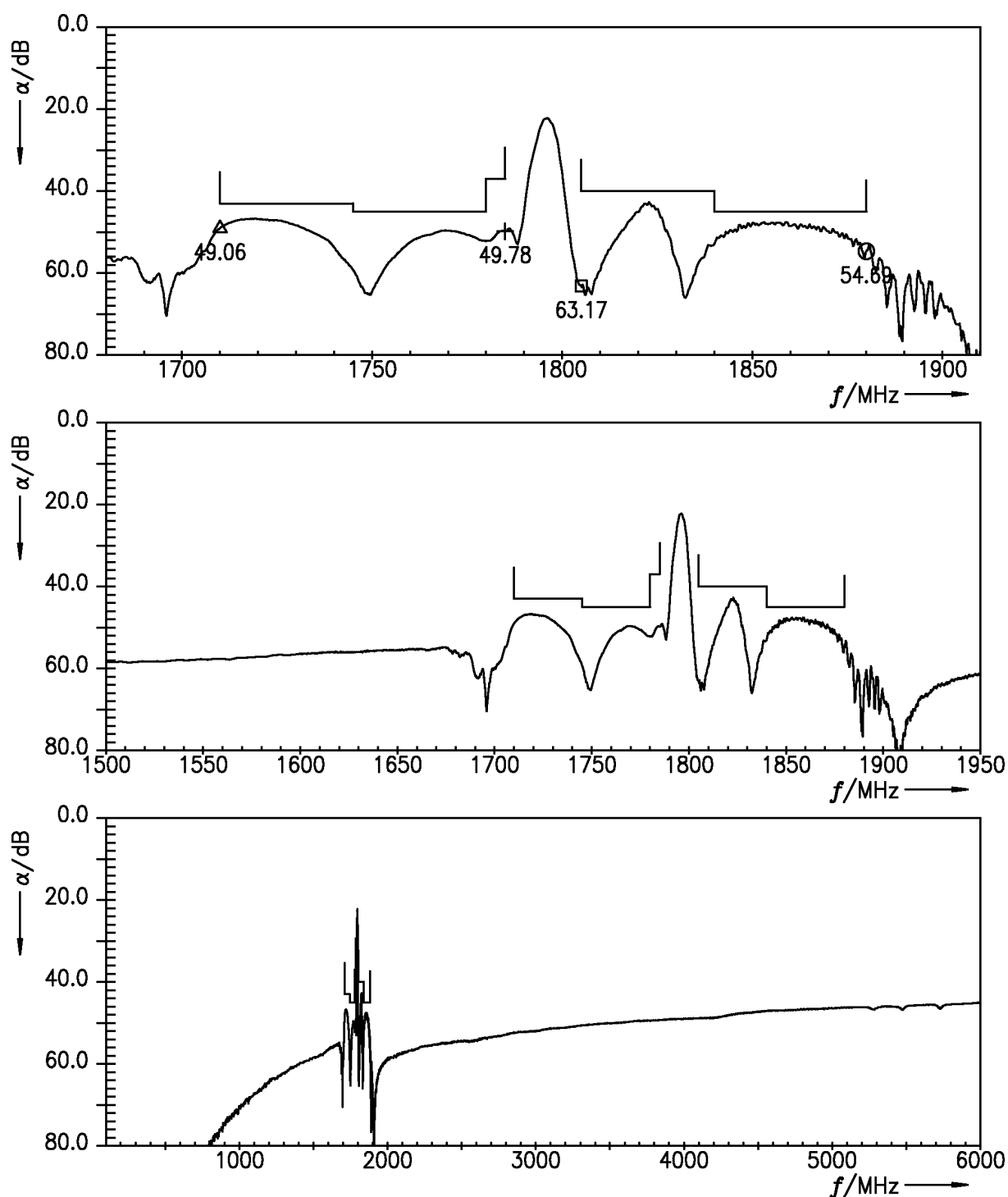


Figure 6: Isolation TX – RX.

Data sheet

9 Reflection coefficients

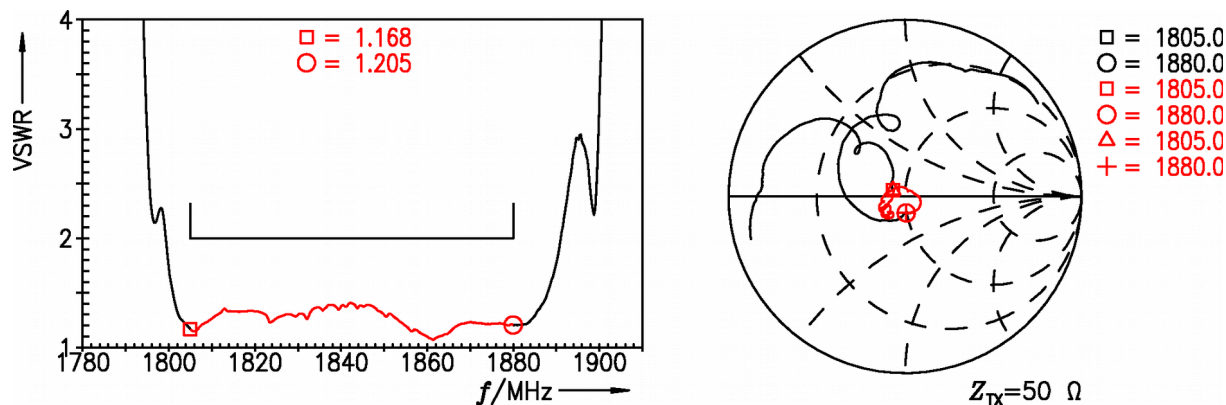


Figure 7: Reflection coefficient at TX port.

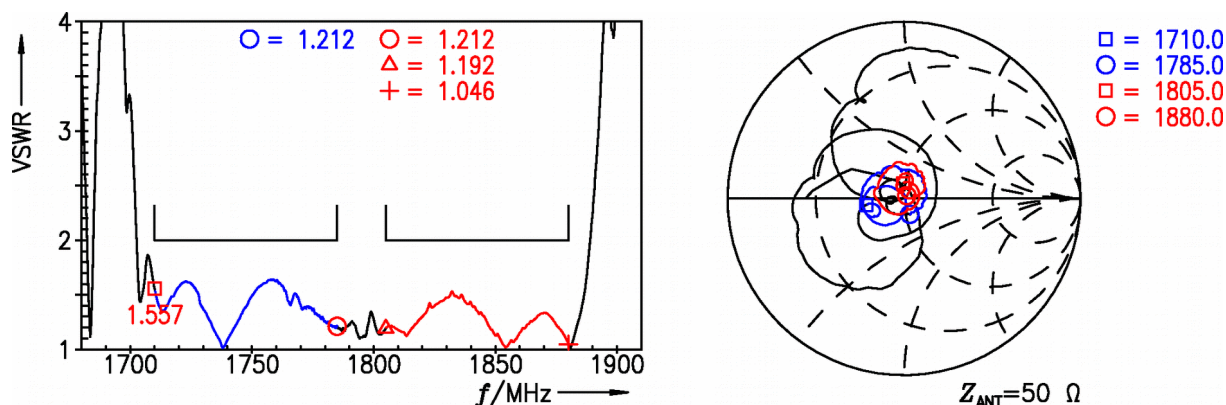


Figure 8: Reflection coefficient at ANT port (TX and RX frequencies).

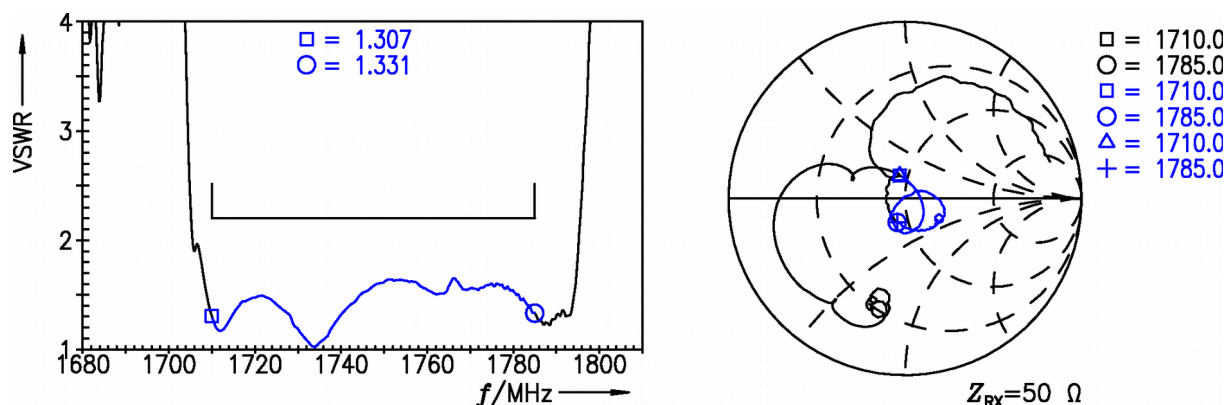


Figure 9: Reflection coefficient at RX port.

Data sheet

10 EVMs

10.1 TX – ANT

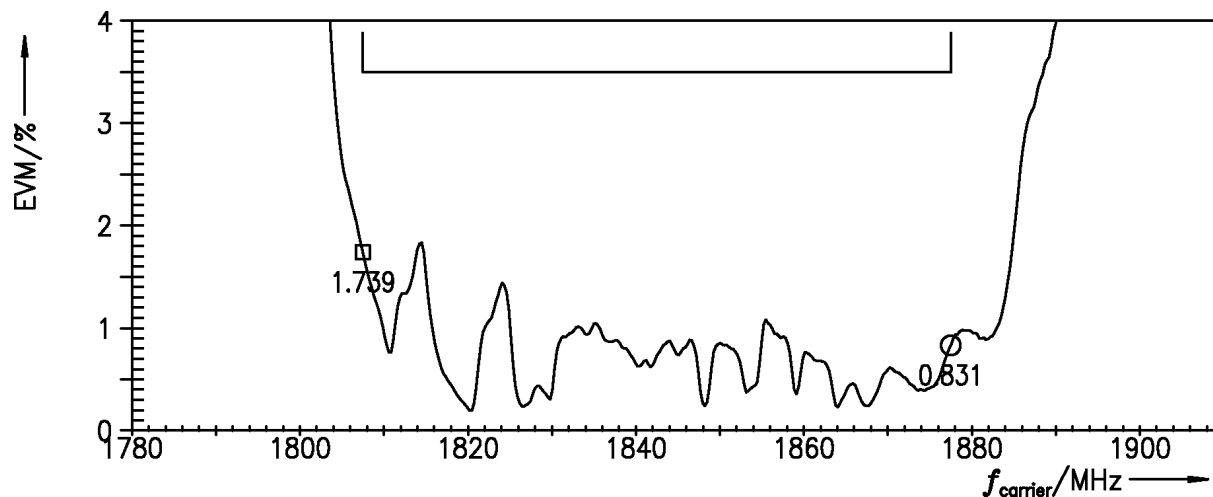


Figure 10: Error vector magnitude TX – ANT.

Data sheet

10.2 ANT – RX

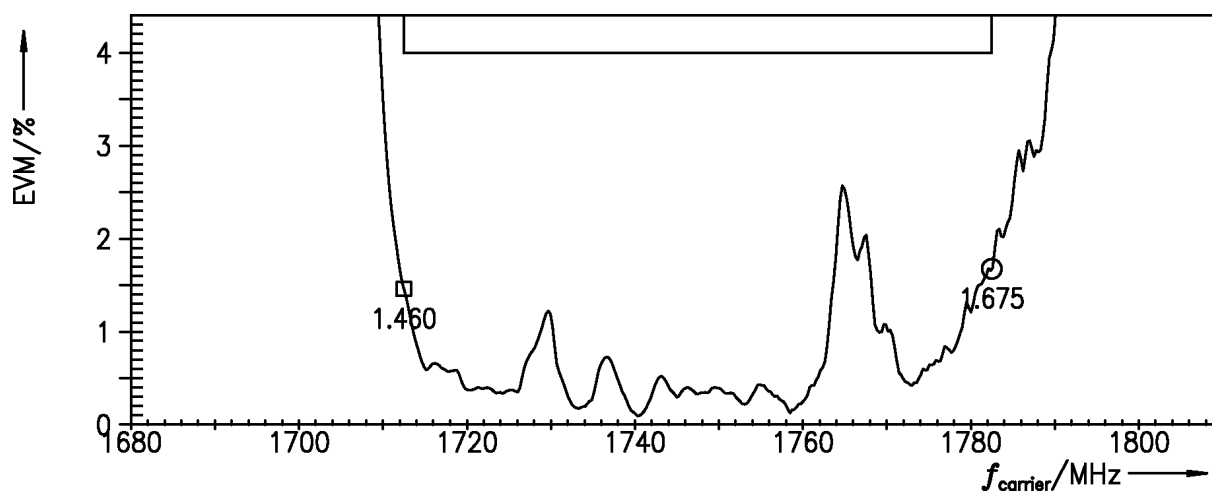
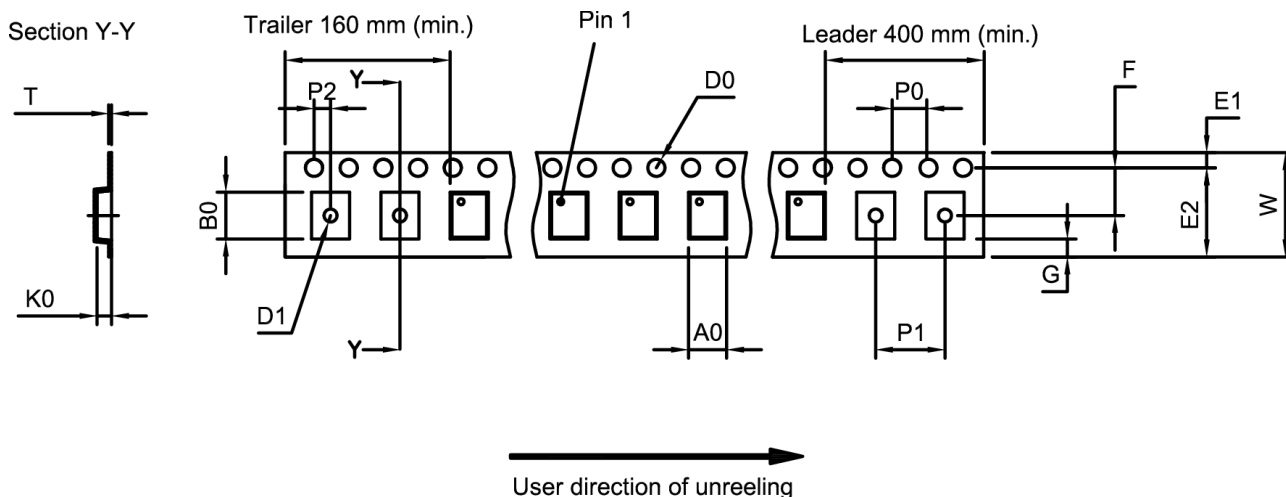


Figure 11: Error vector magnitude ANT – RX.

Data sheet

11 Packing material

11.1 Tape


Figure 12: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

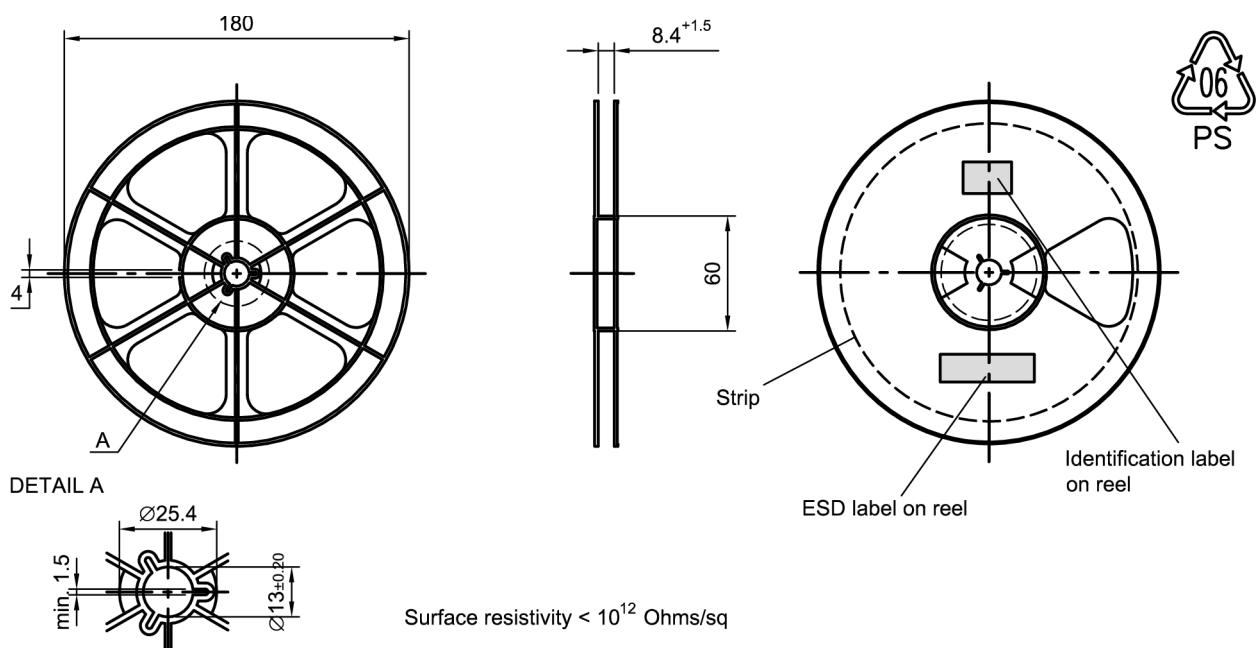
A ₀	2.25±0.05 mm
B ₀	2.75±0.05 mm
D ₀	1.5+0.1/-0 mm
D ₁	1.0 mm (min.)
E ₁	1.75±0.1 mm

E ₂	6.25 mm (min.)
F	3.5±0.05 mm
G	0.75 mm (min.)
K ₀	0.6±0.05 mm
P ₀	4.0±0.1 mm

P ₁	4.0±0.1 mm
P ₂	2.0±0.05 mm
T	0.25±0.03 mm
W	8.0+0.3/-0.1 mm

Table 1: Tape dimensions.

11.2 Reel with diameter of 180 mm


Figure 13: Drawing of reel (first-angle projection) with diameter of 180 mm.

Data sheet

Dimensions [mm]

X = 220±5

Y = 235±5

Sealing area 10±3

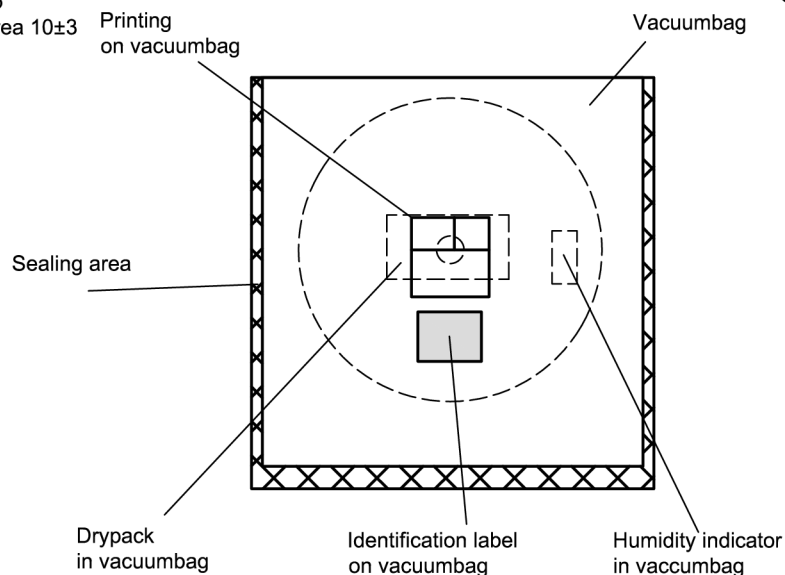


Figure 14: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

Dimensions [mm]

L = 188

B = 188

H = 30

Tolerance ±5

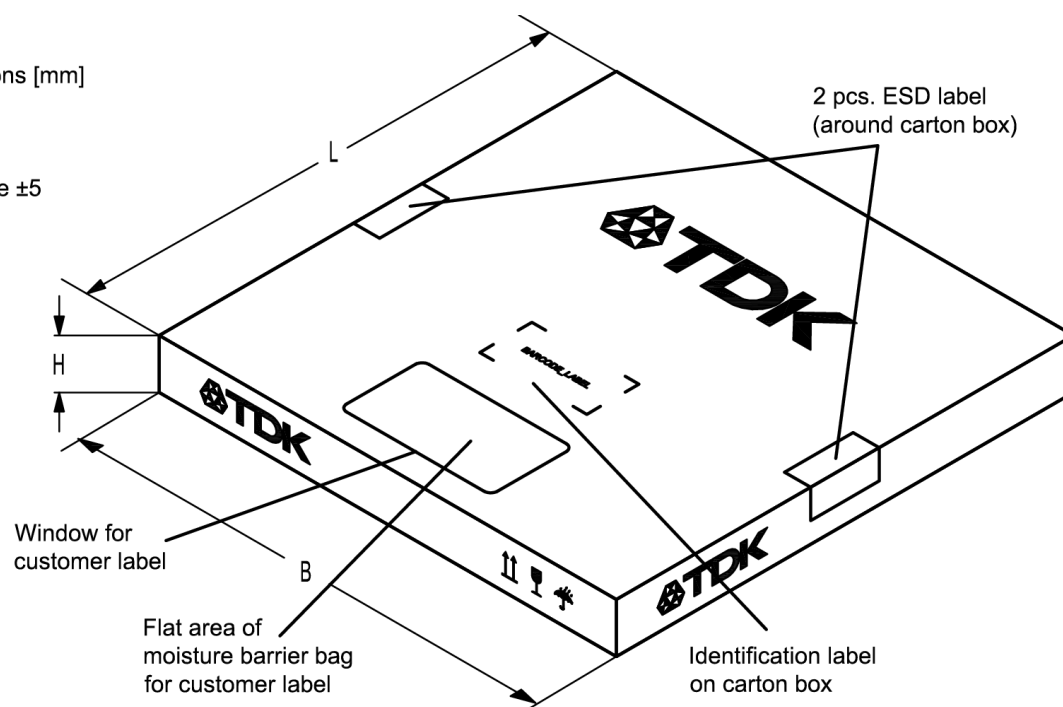


Figure 15: Drawing of folding box for reel with diameter of 180 mm.

Data sheet

11.3 Reel with diameter of 330 mm

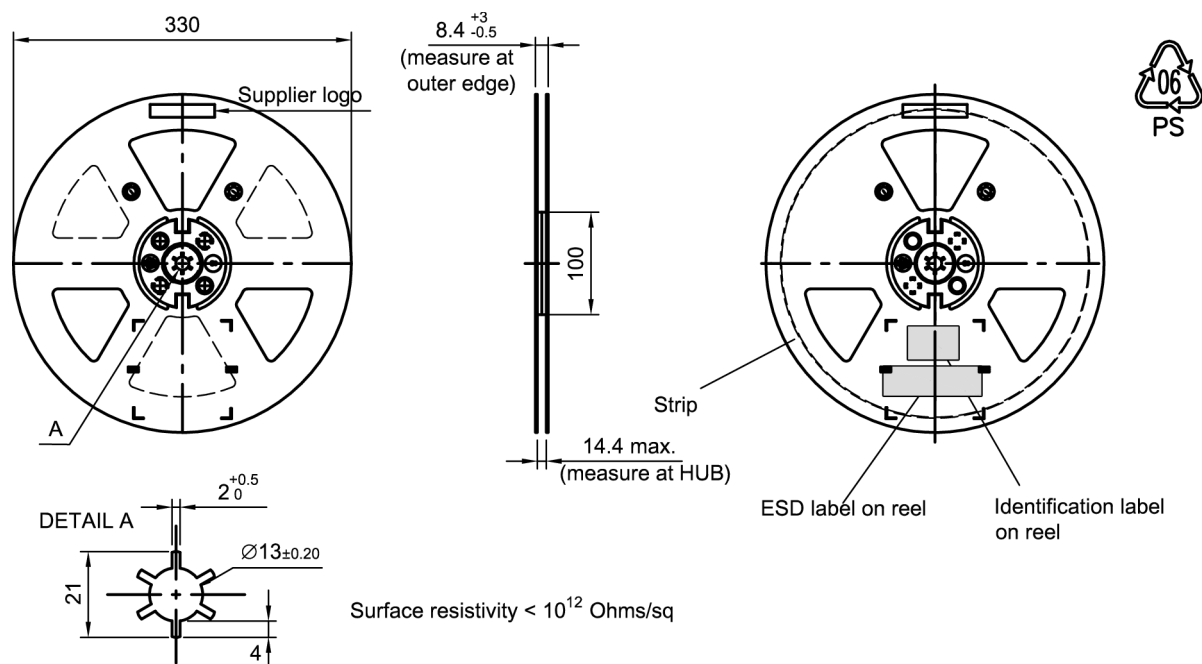


Figure 16: Drawing of reel (first-angle projection) with diameter of 330 mm.

Dimensions [mm]

X = 400+5

Y = 418+5

Sealing area 10±3

Printing on vacuumbag

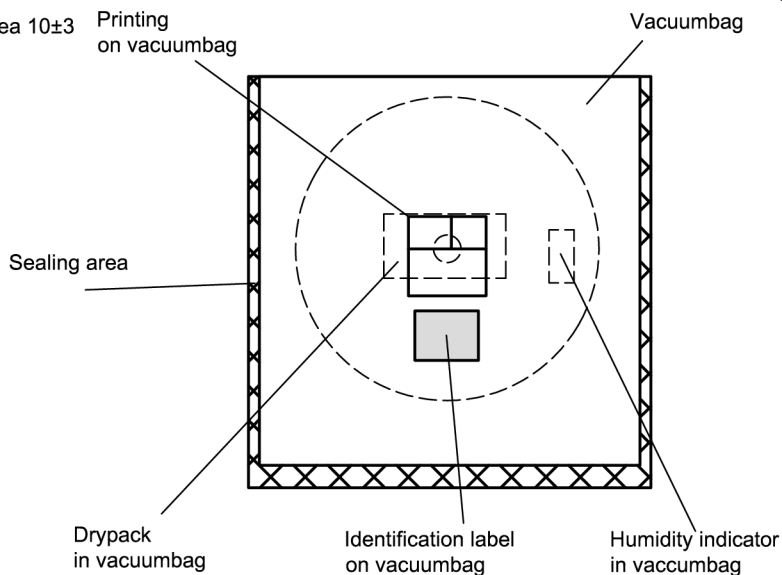


Figure 17: Drawing of moisture barrier bag (MBB) for reel with diameter of 330 mm.

Data sheet

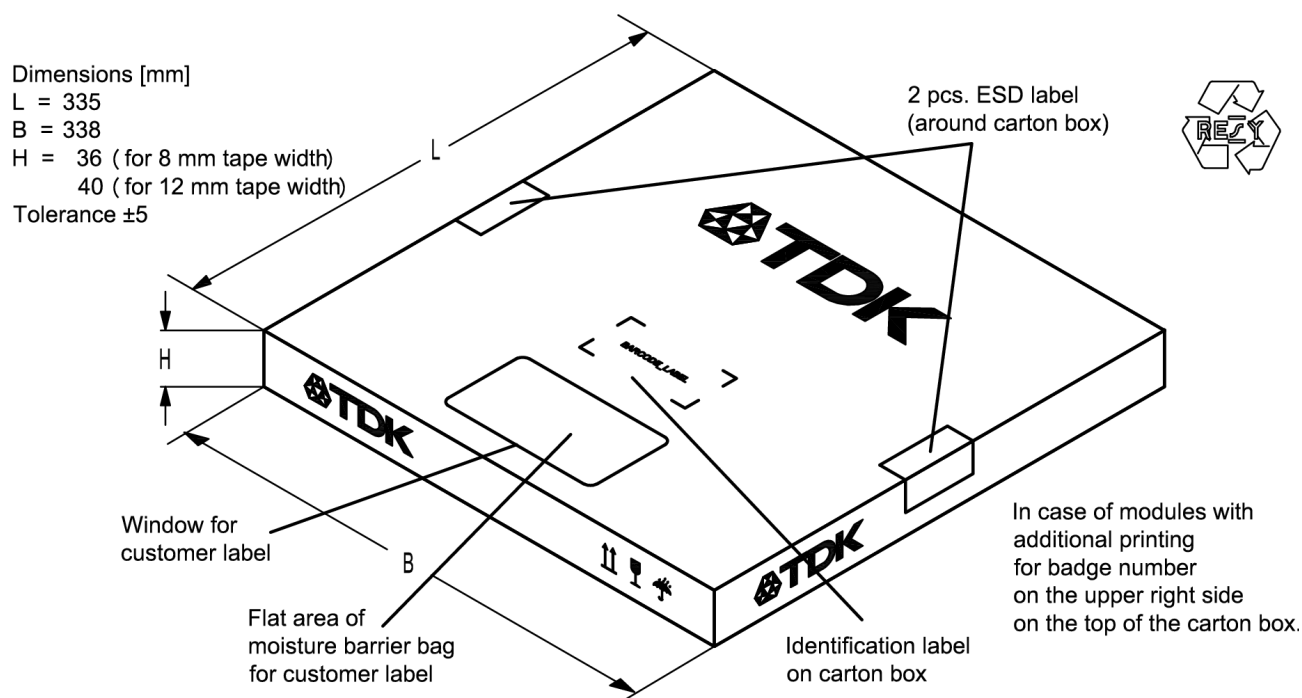


Figure 18: Drawing of folding box for reel with diameter of 330 mm.

12 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:

The 4 digit type number of the ordering code, is encoded by a special BASE32 code into a 3 digit marking.

e.g., B3xxxxB**1234**xxxx,

Example of decoding type number marking on device

in decimal code.

16J

=>

1234

$1 \times 32^2 + 6 \times 32^1 + 18 (=J) \times 32^0$

=

1234

The BASE32 code for product type B8018 is 7TJ.

■ Lot number:

The last 5 digits of the lot number, are encoded based on a special BASE47 code into a 3 digit marking.

e.g., **12345**,

Example of decoding lot number marking on device

in decimal code.

5UY

=>

12345

$5 \times 47^2 + 27 (=U) \times 47^1 + 31 (=Y) \times 47^0$

=

12345

Data sheet

Adopted BASE32 code for type number			
Decimal value	Base32 code	Decimal value	Base32 code
0	0	16	G
1	1	17	H
2	2	18	J
3	3	19	K
4	4	20	M
5	5	21	N
6	6	22	P
7	7	23	Q
8	8	24	R
9	9	25	S
10	A	26	T
11	B	27	V
12	C	28	W
13	D	29	X
14	E	30	Y
15	F	31	Z

Adopted BASE47 code for lot number			
Decimal value	Base47 code	Decimal value	Base47 code
0	0	24	R
1	1	25	S
2	2	26	T
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	X
7	7	31	Y
8	8	32	Z
9	9	33	b
10	A	34	d
11	B	35	f
12	C	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	v
17	H	41	\
18	J	42	?
19	K	43	{
20	L	44	}
21	M	45	<
22	N	46	>
23	P		

Table 2: Lists for encoding and decoding of marking.

SAW components	B8018
SAW duplexer for small cell	1747.5/1842.5

Data sheet

13 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3rd edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
$T > 220\text{ °C}$	30 s to 70 s
$T > 230\text{ °C}$	min. 10 s
$T > 245\text{ °C}$	max. 20 s
$T \geq 255\text{ °C}$	–
peak temperature T_{peak}	250 °C +0/-5 °C
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

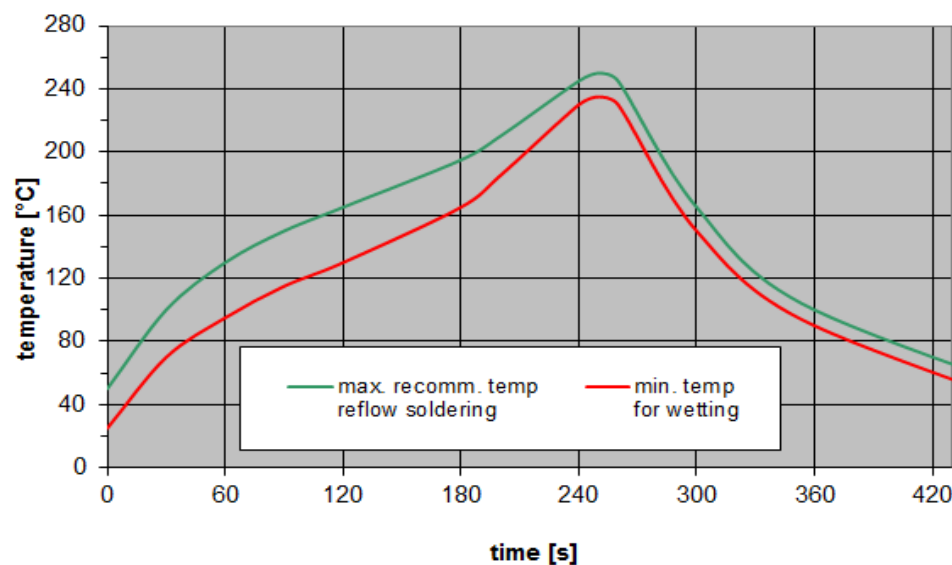


Figure 19: Recommended reflow profile for convection and infrared soldering – lead-free solder.

SAW components	B8018
SAW duplexer for small cell	1747.5/1842.5

Data sheet

14 Annotations

14.1 Matching coils

See TDK inductor pdf-catalog <http://www.tdk.co.jp/tefe02/coil.htm#aname1> and Data Library for circuit simulation <http://www.tdk.co.jp/etvcl/index.htm>.

14.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

14.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local EPCOS sales office.

14.4 Ordering codes and packing units

Ordering code	Packing unit
B39182B8018P810	5000 pcs

Table 4: Ordering codes and packing units.

Data sheet

15 Cautions and warnings

15.1 Display of ordering codes for EPCOS products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of EPCOS, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.epcos.com/orderingcodes.

15.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

15.3 Moldability

Before using in overmolding environment, please contact your local EPCOS sales office.

15.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on EPCOS internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of EPCOS, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Dimensions do not include burrs.

Projection method

Unless otherwise specified first-angle projection is applied.

Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified**. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet (www.epcos.com/material). Should you have any more detailed questions, please contact our sales offices.
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